

CMOS Presettable Up/Down Counters (Dual Clock With Reset)

High-Voltage Types (20-Volt Rating)

CD40192 – BCD Type

CD40193 – Binary Type

■ CD40192B Presettable BCD Up/Down Counter and the CD40193B Presettable Binary Up/Down Counter each consist of 4 synchronously clocked, gated "D" type flip-flops connected as a counter. The inputs consist of 4 individual jam lines, a PRESET ENABLE control, individual CLOCK UP and CLOCK DOWN signals and a master RESET. Four buffered Q signal outputs as well as CARRY and BORROW outputs for multiple-stage counting schemes are provided.

The counter is cleared so that all outputs are in a low state by a high on the RESET line. A RESET is accomplished asynchronously with the clock. Each output is individually programmable asynchronously with the clock to the level on the corresponding jam input when the PRESET ENABLE control is low.

The counter counts up one count on the positive clock edge of the CLOCK UP signal provided the CLOCK DOWN line is high. The counter counts down one count on the positive clock edge of the CLOCK DOWN signal provided the CLOCK UP line is high.

The CARRY and BORROW signals are high when the counter is counting up or down. The CARRY signal goes low one-half clock cycle after the counter reaches its maximum count in the count-up mode. The BORROW signal goes low one-half clock cycle after the counter reaches its minimum count in the count-down mode. Cascading of multiple packages is easily accomplished without the need for additional external circuitry by tying the BORROW and CARRY outputs to the CLOCK DOWN and CLOCK UP inputs, respectively, of the succeeding counter package.

The CD40192B and CD40193B types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline package (NSR suffix), and in chip form (H suffix).

CD40192B, CD40193B Types

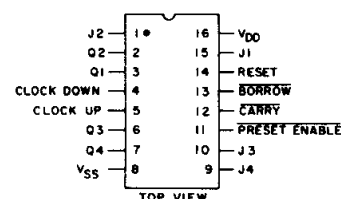
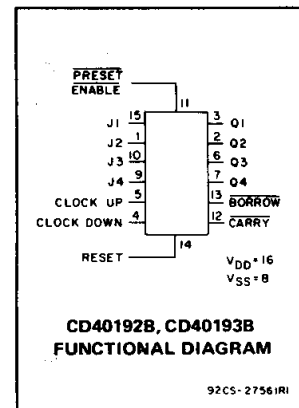
Features:

- Individual clock lines for counting up or counting down
- Synchronous high-speed carry and borrow propagation delays for cascading
- Asynchronous reset and preset capability
- Medium-speed operation— $f_{CL} = 8 \text{ MHz (typ.) @ } 10 \text{ V}$
- 5-V, 10-V, and 15-V parametric ratings
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of $1 \mu\text{A}$ at 18 V over full package temperature range; 100 nA at 18 V and 25°C
- Noise margin over full package temperature range:
 - 1 V at $V_{DD} = 5 \text{ V}$ 2 V at $V_{DD} = 10 \text{ V}$
 - 2.5 V at $V_{DD} = 15 \text{ V}$

- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

Applications:

- Up/down difference counting
- Multistage ripple counting
- Synchronous frequency dividers
- A/D and D/A conversion
- Programmable binary or BCD counting



CD40192B, CD40193B
TERMINAL ASSIGNMENT

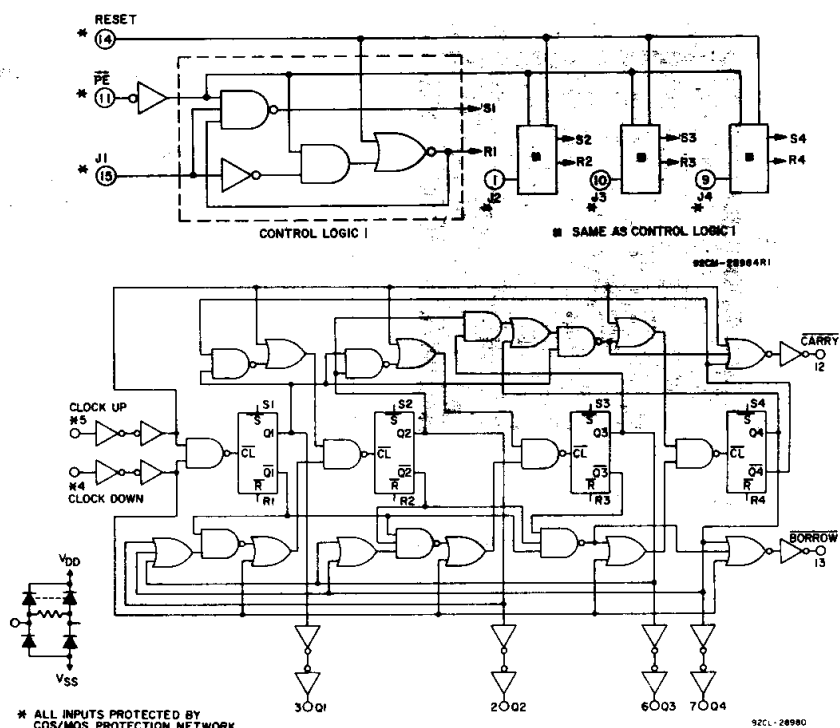


Fig. 1 – CD40192B logic diagram (BCD).

CD40192B, CD40193B Types

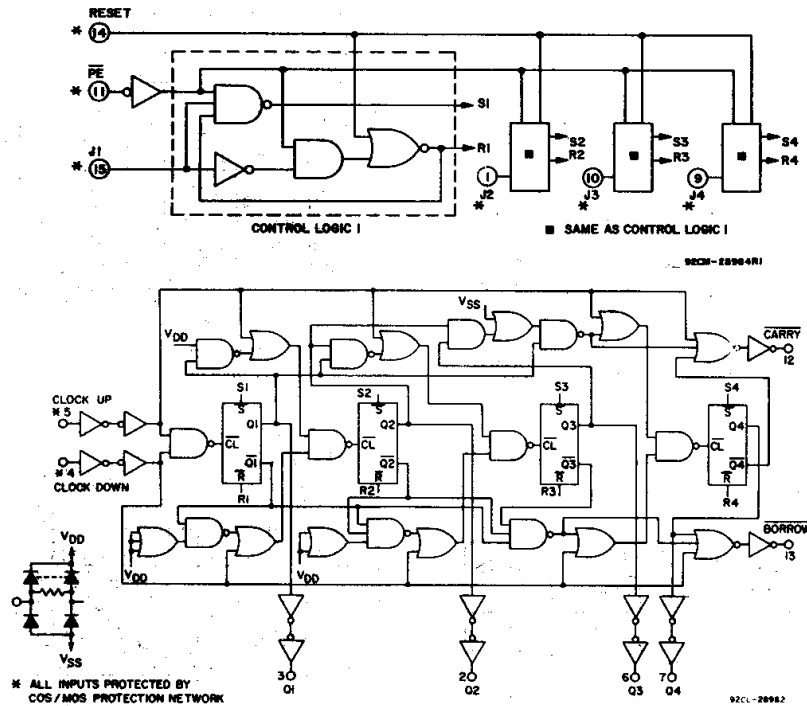


Fig. 2 - CD40193B logic diagram (binary).

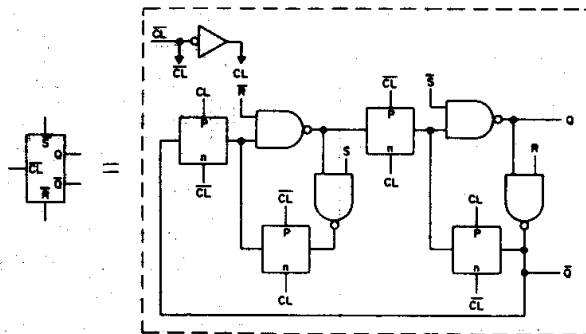


Fig. 4 - Internal logic of Flip-flop.

TRUTH TABLE

CLOCK UP	CLOCK DOWN	PRESET ENABLE	RESET	ACTION
	1	1	0	COUNT UP
	1	1	0	NO COUNT
1		1	0	COUNT DOWN
1		1	0	NO COUNT
X	X	0	0	PRESET
X	X	X	1	RESET

1 = HIGH LEVEL

0 = LOW LEVEL

X = DON'T CARE

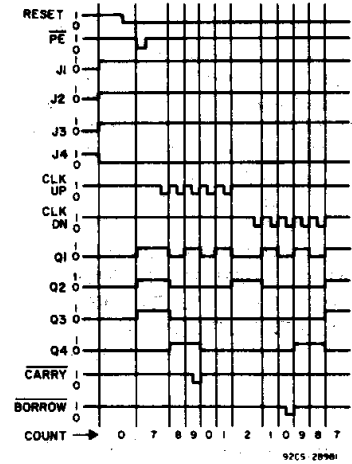


Fig. 3 - CD40192B timing diagram.

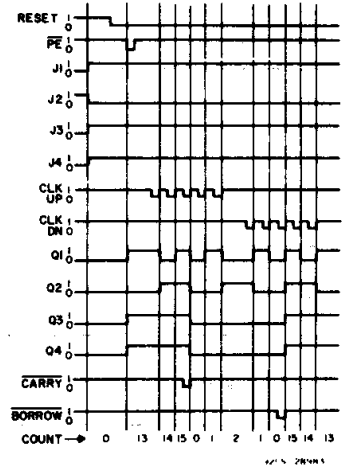


Fig. 5 - CD40193B timing diagram.

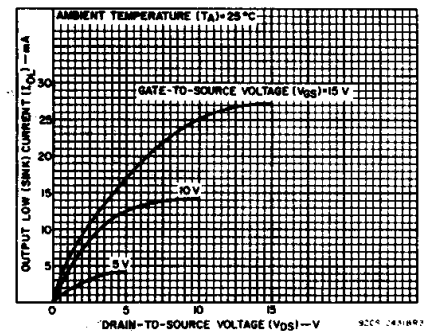


Fig. 6 - Typical output low (sink) current characteristics.

CD40192B, CD40193B Types

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V_{DD})

Voltages referenced to V_{SS} Terminal) -0.5V to +20V

INPUT VOLTAGE RANGE, ALL INPUTS -0.5V to $V_{DD} + 0.5V$

DC INPUT CURRENT, ANY ONE INPUT $\pm 10mA$

POWER DISSIPATION PER PACKAGE (P_D):

For $T_A = -55^\circ C$ to $+100^\circ C$ 500mW

For $T_A = +100^\circ C$ to $+125^\circ C$ Derate Linearity at 12mW/ $^\circ C$ to 200mW

DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR $T_A =$ FULL PACKAGE-TEMPERATURE RANGE (All Package Types) 100mW

OPERATING-TEMPERATURE RANGE (T_A) $-55^\circ C$ to $+125^\circ C$

STORAGE TEMPERATURE RANGE (T_{stg}) $-65^\circ C$ to $+150^\circ C$

LEAD TEMPERATURE (DURING SOLDERING):

At distance $1/16 \pm 1/32$ Inch ($1.59 \pm 0.79mm$) from case for 10s max $+265^\circ C$

RECOMMENDED OPERATING CONDITIONS at $T_A = 25^\circ C$ (unless otherwise specified)

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

CHARACTERISTIC	V_{DD} (V)	LIMITS		UNITS
		Min.	Max.	
Supply Voltage Range (For $T_A =$ Full Temp. Range)	—	3	18	V
Removal Time: RESET or $\overline{PE}$	5	80	—	ns
	10	40	—	ns
	15	30	—	ns
Pulse Width: RESET	5	480	—	ns
	10	300	—	ns
	15	260	—	ns
$\overline{PE}$	5	240	—	ns
	10	170	—	ns
	15	140	—	ns
CLOCK	5	180	—	ns
	10	90	—	ns
	15	60	—	ns
Clock Input Frequency	5	—	2	MHz
	10	DC	4	MHz
	15	—	5.5	MHz
Clock Rise & Fall Time	5	—	15	μs
	10	—	15	μs
	15	—	5	μs

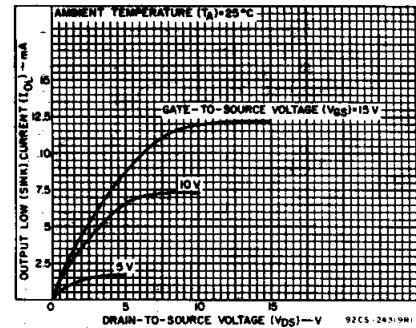


Fig. 7 - Minimum output low (sink) current characteristics.

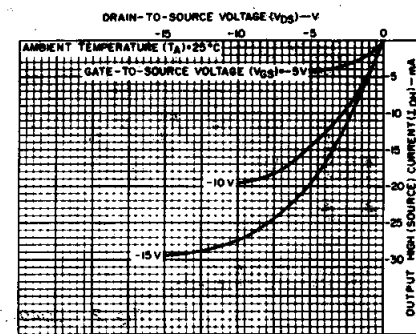


Fig. 8 - Typical output high (source) current characteristics.

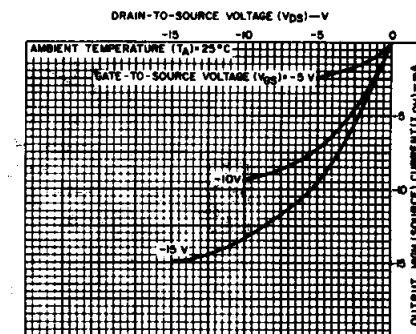


Fig. 9 - Minimum output high (source) current characteristics.

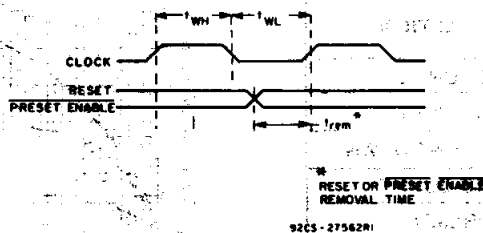


Fig. 10 - Timing diagram defining t_{rem}

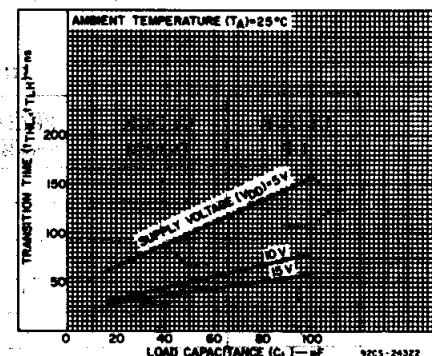


Fig. 11 - Typical transition time as a function of load capacitance.

CD40192B, CD40193B Types

STATIC ELECTRICAL CHARACTERISTICS

CHARACTER- ISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							UNITS
	V _O (V)	V _{IN} (V)	V _{DD} (V)	+25							
				-55	-40	+85	+125	Min.	Typ.	Max.	
Quiescent Device Current, I _{DD} Max.	—	0,5	5	5	5	150	150	—	0.04	5	μA
	—	0,10	10	10	10	300	300	—	0.04	10	
	—	0,15	15	20	20	600	600	—	0.04	20	
	—	0,20	20	100	100	3000	3000	—	0.08	100	
Output Low (Sink) Current I _{OL} Min.	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	—	mA
	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	—	
	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	—	
Output High (Source) Current, I _{OH} Min.	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	—	mA
	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	—	
	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	—	
	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	—	
Output Voltage: Low-Level, V _{OL} Max.	—	0,5	5	0.05				—	0	0.05	V
	—	0,10	10	0.05				—	0	0.05	
	—	0,15	15	0.05				—	0	0.05	
Output Voltage: High-Level, V _{OH} Min.	—	0,5	5	4.95				4.95	5	—	V
	—	0,10	10	9.95				9.95	10	—	
	—	0,15	15	14.95				14.95	15	—	
Input Low Voltage, V _{IL} Max.	0.5, 4.5	—	5	1.5				—	—	1.5	V
	1, 9	—	10	3				—	—	3	
	1.5, 13.5	—	15	4				—	—	4	
Input High Voltage, V _{IH} Min.	0.5, 4.5	—	5	3.5				3.5	—	—	V
	1, 9	—	10	7				7	—	—	
	1.5, 13.5	—	15	11				11	—	—	
Input Current I _{IN} Max.	—	0,18	18	±0.1	±0.1	±1	±1	—	±10 ⁻⁵	±0.1	μA

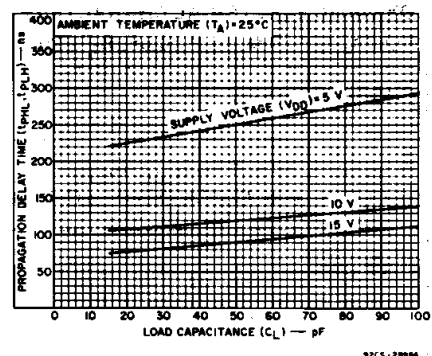


Fig. 12 — Typical propagation delay time as a function of load capacitance.

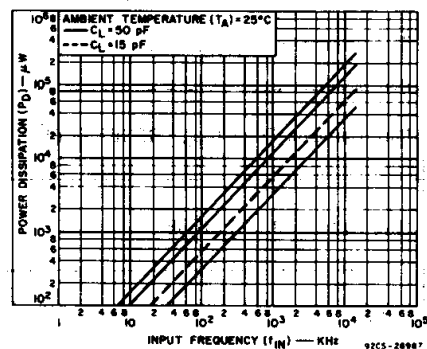
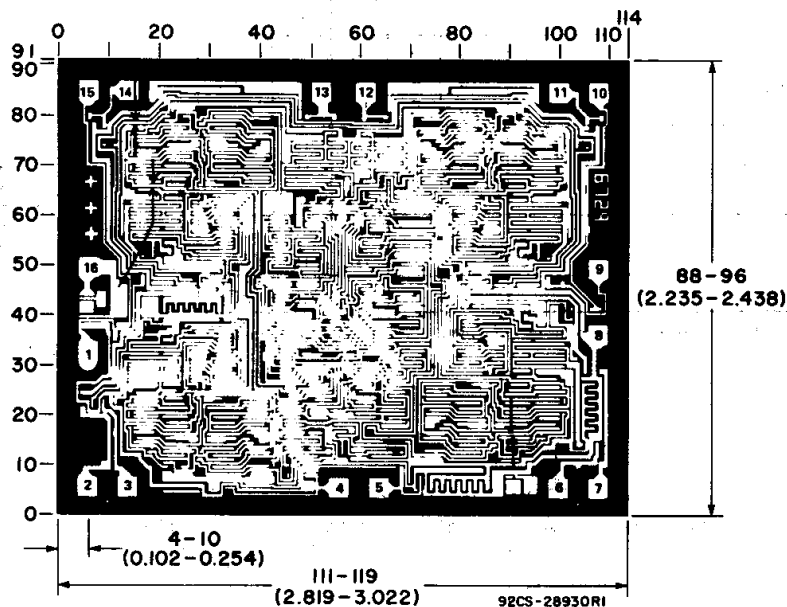


Fig. 13 — Dynamic power dissipation.



Dimensions and pad layout for the CD40192BH (dimensions and pad layout for the CD40193BH are identical).

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10⁻³ inch).

CD40192B, CD40193B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$

Input $t_r, t_f = 20 \text{ ns}$, $C_L = 50 \text{ pF}$, $R_L = 200 \text{ k}\Omega$

CHARACTERISTIC	V_{DD} (V)	LIMITS			UNITS
		Min.	Typ.	Max.	
Propagation Delay Time t_{PHL}, t_{PLH} : CLOCK UP or CLOCK DOWN to Q, RESET to Q	5 10 15	— — —	250 120 90	500 240 180	ns
$\overline{PE}$ to Q	5 10 15	— — —	200 100 70	400 200 140	ns
CLOCK UP to $\overline{CARRY}$, CLOCK DOWN to $\overline{BORROW}$	5 10 15	— — —	160 80 60	320 160 120	ns
RESET or $\overline{PE}$ to $\overline{BORROW}$ or $\overline{CARRY}$	5 10 15	— — —	300 150 110	600 300 220	ns
Transition Time, t_{THL}, t_{TLH}	5 10 15	— — —	100 50 40	200 100 80	ns
Min. Removal Time, t_{rem} * RESET or $\overline{PE}$	5 10 15	— — —	40 20 15	80 40 30	ns
Min. Pulse Width, t_w RESET	5 10 15	— — —	240 150 130	480 300 260	ns
$\overline{PE}$	5 10 15	— — —	120 85 70	240 170 140	ns
CLOCK	5 10 15	— — —	90 45 30	180 90 60	ns
Max. Clock Input Frequency, f_{CL}	5 10 15	2 4 5.5	4 8 11	— — —	MHz
Clock Rise & Fall Time, t_r, t_f	5 10 15	— — —	— — —	15 15 5	μs
Input Capacitance, C_{IN} : RESET	—	—	10	15	pF
All Other Inputs	—	—	5	7.5	pF

* The time required for RESET or PRESET ENABLE control to be removed before clocking (see timing diagram, Fig. 10).

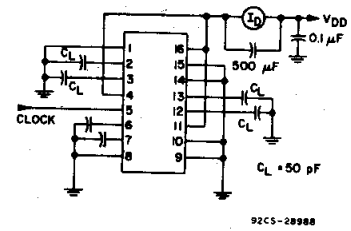


Fig. 14 - Dynamic power dissipation test circuit.

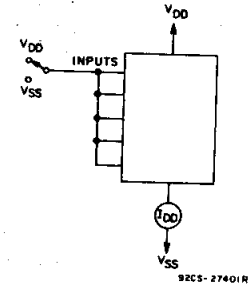


Fig. 15 - Quiescent device current test circuit.

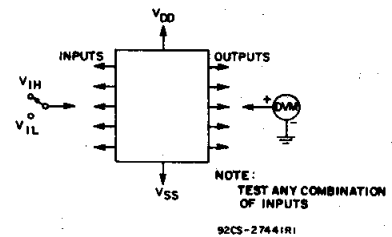


Fig. 16 - Input voltage test circuit.

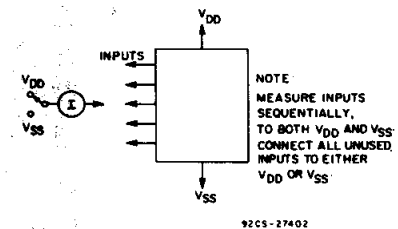


Fig. 17 - Input current test circuit.

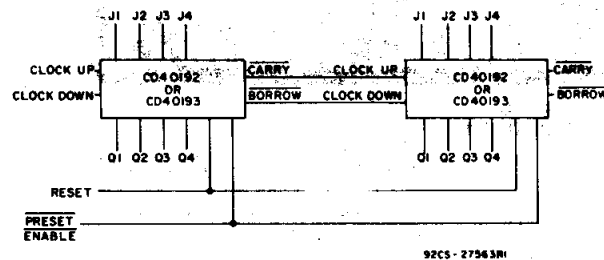


Fig. 18 - Cascaded counter packages.

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